TS63420K – 1.9Ω On Resistance GaN Broadband RF Switch SP4T

1.0 Features

- Ultra low 1.9Ω on resistance
- 0.35pF C_{off}
- RF peak voltage handling of 100V
- Each state can be controlled independently
- 16 possible independent state configuration
- No external DC blocking capacitors on RF lines
- Versatile 2.6~5.5V power supply
- 1.2~5.0V digital control

Filter and antenna tuning

Public safety handsets

Cellular infrastructure

Private mobile radio handsets

2.0 Applications



Figure 1 Device Image (16 Pin 3×3×0.8mm QFN Package)



RoHS/REACH/Halogen Free Compliance

Satellite terminals

Dynamic matching

3.0 Description

The TS63420K is a reflective open Single Pole Four Throw (SP4T) switch designed for antenna or filter tuning applications where high RF peak voltage handling is desired. TS63420K is suitable for frequency range from 1MHz to 1GHz. The TS63420K has a very low 1.9Ω on resistance and off capacitance of 0.35pF. This switch can select up to 16 independent states.

The TS63420K is packaged in a compact Quad Flat No lead (QFN) 3x3mm 16 leads plastic package.

4.0 Ordering Information

Table 1 Ordering Information

Base Part Number	Package Type	Form	Qty	Reel Diameter	Reel Width	Orderable Part Number
TS63420K	16 Pin 3×3×0.8mm QFN	Tape and Reel	3000	13" (330mm)	18mm	TS63420KMTRPBF
Evaluation Board						TS63420K-EVB



Figure 2 Function Block Diagram (Top View)

5.0 Pin Description

Table 2 Pin Definition

Pin Number	Pin Name	Description
1	V1	Switch control input 1
2	V2	Switch control input 2
3	V3	Switch control input 3
4	V4	Switch control input 4
5,6,8,13,14	NC	No internal connection, can be grounded
7	ANT	Antenna port
9	RF4	RF port 4
10	RF3	RF port 3
11	RF2	RF port 2
12	RF1	RF port 1
15	VCP	Internal charge pump voltage output. Connect a 1nF capacitor to GND on this pin to improve switching time.
16	VDD	DC power supply

Note: The backside ground (thermal) pad of the package must be grounded directly to the ground plane of PCB with multiple vias to ensure proper operation and thermal management.

6.0 Absolute Maximum Ratings

Table 3 Absolute Maximum Ratings @T_A=+25°C Unless Otherwise Specified

Parameter	Symbol	Value	Unit				
Electrical Ratings							
Power Supply Voltage	VDD	2.6 to 5.5	V				
Storage Temperature Range	T _{st}	-55 to +125	°C				
Operating Temperature Range	T _{op}	-40 to +85	°C				
Maximum Junction Temperature	TJ	+140	°C				
RF Input Power CW, 800MHz	RFx	41	dBm				
Thermal Ra	tings						
Thermal Resistance (junction-to-case) – Bottom side	Rejc	20	°C/W				
Thermal Resistance (junction-to-top)	Rejt	≤ 39	°C/W				
Soldering Temperature	TSOLD	260	°C				
ESD Rati	ngs		•				
Human Body Model (HBM)	Level 1B	500 to <1000	V				
Charged Device Model (CDM)	Level C3	≥1000	V				
Moisture R	ating						
Moisture Sensitivity Level	MSL	1	-				

Attention:

Maximum ratings are absolute ratings. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Exceeding one or a combination of the absolute maximum ratings may cause permanent and irreversible damage to the device and/or to surrounding circuit.

7.0 Electrical Specifications

Parameter	Condition	Minimum	Typical	Maximum	Unit
Operating Frequency		10		1000	MHz
ON Resistance	On state, DC measurement		1.9		Ω
OFF Capacitance	Total capacitance of each OFF path		0.35		pF
RF Peak Voltage	Measured with 50Ω		100		V
Insertion Loss, RFx	100MHz		0.25		dB
	500MHz		0.40		
	1.0GHz		0.60		
Isolation ANT-RFx	100MHz		37		dB
	500MHz		25		
	1.0GHz		20		
Return Loss ANT-	100MHz		30		dB
RFx	500MHz		18		
	1.0GHz		16		
H2	800MHz, Pin=35dBm		80		dBc
H3	800MHz, Pin=35dBm		85		dBc
IIP3	800MHz		71		dBm
	1~10MHz		40		dBm
P0.1dB ^[1]	10~1000MHz		42		dBm
Switching Time	50% ctrl to 10/90% of the RF value is settled. C1=1nF to Gnd on VCP		2.0		μs
Start-up Time	50% ctrl to 10/90% of the RF value is settled. C1=1nF to Gnd on VCP		TBD		μs
Control Voltage	Power supply VDD	2.6	2.7	5.5	V
	All control pins high, Vih	1.0	2.7	5.25	V
	All control pins low, Vil	-0.3		0.5	V
Control Current	All control pins low, Iii		0		μA
	All control pins high, I _{ih}			7.5	μA
Current Consumption, IDD	Active mode		160	200	μA

Table 4 Electrical Specifications @T_A=+25°C Unless Otherwise Specified; VDD=+2.7V; 50Ω Source/Load.

Note:

[1] P0.1dB is a figure of merit.

[2] No external DC blocking capacitors required on RF pins unless DC voltage is applied on a RF pin.

[3] Start-up time is the time from VDD ON to RF signal settled on a throw or transition time from low power mode to active mode.

8.0 Switch Truth Table

Table 5 Switch Truth Table

V1	V2	V3	V4	Active RF Path
0	0	0	0	All OFF state
0	0	0	1	RF4
0	0	1	0	RF3
0	0	1	1	RF3, RF4
0	1	0	0	RF2
0	1	0	1	RF2, RF4
0	1	1	0	RF2, RF3
0	1	1	1	RF2, RF3, RF4
1	0	0	0	RF1
1	0	0	1	RF1, RF4
1	0	1	0	RF1, RF3
1	0	1	1	RF1, RF3, RF4
1	1	0	0	RF1, RF2
1	1	0	1	RF1, RF2, RF4
1	1	1	0	RF1, RF2, RF3
1	1	1	1	All ON state

Attention:

- [1] VDD should be applied first before V1, V2, V3 and V4, otherwise may cause damage to the device.
- [2] There are internal pull-downs to ground on all control pins, the state at start-up without any control voltage applied will be All OFF.

9.0 Evaluation Board



Figure 3 Evaluation Board Schematic



Figure 4 Evaluation Board Image

Table 6 Recommended Values		
Component	Value	Unit
Ср	0.25	pF
Coff	0.35	pF
Bourr	1.9 if ON	Ω
Rswx	500K if OFF	Ω
Ls	0.4	nH

Note: Ron/Off is measured at DC. This model will not accurately predict losses in a tunable filter or antenna design



TS63420K

10.0 Typical Characteristics



Figure 5 RF1 - 4 Insertion Loss



Figure 7 Return Loss

Figure 6 RF2 - 4 Isolation

11.0 Device Package Information



Figure 8 Device Package Drawing

(All dimensions are in mm)

Table 7 Device Package Dimensions

Dimension (mm)	Value (mm)	Tolerance (mm)	Dimension (mm)	Value (mm)	Tolerance (mm)
А	0.80	±0.05	E	3.00 BSC	±0.05
A1	0.203	±0.02	E1	1.70	±0.05
b	0.25	+0.05/-0.07	F	0.625	±0.05
D	3.00 BSC	±0.05	G	0.625	±0.05
D1	1.70	±0.05	L	0.25	±0.05
е	0.50 BSC	±0.05	K	0.40	±0.05

Note: Lead finish: Pure Sn without underlayer; Thickness: 7.5µm ~ 20µm (Typical 10µm ~ 12µm)

Attention:

Please refer to application notes *TN-001* and *TN-002* at http://www.tagoretech.com for PCB and soldering related guidelines.



12.0 PCB Land Design

Guidelines:

- [1] 4 layer PCB is recommended.
- [2] Via diameter is recommended to be 0.2mm to prevent solder wicking inside the vias.
- [3] Thermal vias shall only be placed on the center pad.
- [4] The maximum via number for the center pad is $3(X) \times 3(Y) = 9$.





(Recommended Values: S≥0.15mm; Y≥0.20mm; d=0.2mm; Plating Thickness t=25µm or 50µm)



13.0 PCB Stencil Design

Guidelines:

- [1] Laser-cut, stainless steel stencil is recommended with electro-polished trapezoidal walls to improve the paste release.
- [2] Stencil thickness is recommended to be 125µm.



Figure 12 Stencil Openings (Dimensions are in mm)



Figure 13 Stencil Openings Shall not Cover Via Areas If Possible (Dimensions are in mm)

14.0 Tape and Reel Information



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Figure 14 Tape and Reel Drawing

Table 8 Tape and Reel Dimensions								
Dimension (mm)	Value (mm)	Tolerance (mm)	Dimension (mm)	Value (mm)	Tolerance (mm)			
A0	3.35	±0.10	K0	1.10	±0.10			
B0	3.35	±0.10	P0	4.00	±0.10			
D0	1.50	+0.10/-0.00	P1	8.00	±0.10			
D1	1.50	+0.10/-0.00	P2	2.00	±0.05			
E	1.75	±0.10	Т	0.30	±0.05			
F	5.50	±0.05	W	12.00	±0.30			



Edition Revision 1.6 - 2020-04-24

Published by

Tagore Technology Inc. 5 East College Drive, Suite 200 Arlington Heights, IL 60004, USA

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